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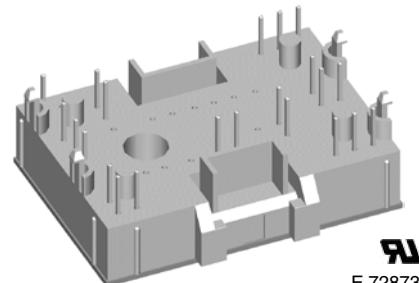
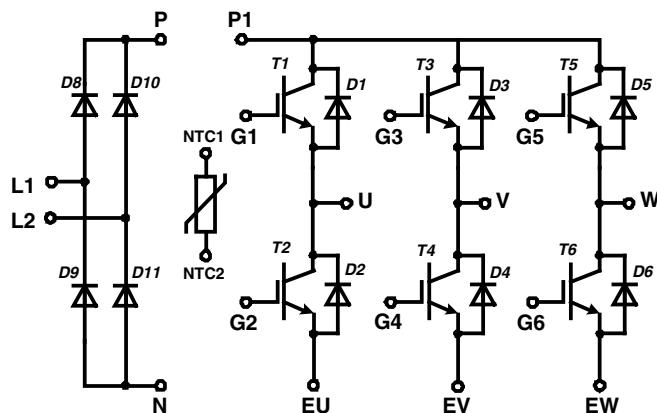
Converter - Inverter Module

NPT IGBT

Single Phase Rectifier	Three Phase Inverter
$V_{RRM} = 1600 \text{ V}$	$V_{CES} = 600 \text{ V}$
$I_{DAVM25} = 65 \text{ A}$	$I_{C25} = 29 \text{ A}$
$I_{FSM} = 550 \text{ A}$	$V_{CE(sat)} = 2.1 \text{ V}$

Part name (Marking on product)

MIAA20WD600TMH



E 72873

Pin configuration see outlines.

Features:

- High level of integration - only one power semiconductor module required for the whole drive
- Inverter with NPT IGBTs
 - low saturation voltage
 - positive temperature coefficient
 - fast switching
 - short tail current
- Epitaxial free wheeling diodes with hiperfast soft reverse recovery
- Temperature sense included

Application:

- AC motor drives
- Pumps, Fans
- Washing machines
- Air-conditioning system
- Inverter and power supplies

Package:

- "Mini" package
- Assembly height is 17 mm
- Insulated base plate
- Pins suitable for wave soldering and PCB mounting
- Assembly clips available
 - IXKU 5-505 screw clamp
 - IXRB 5-506 click clamp
- UL registered E72873

Output Inverter T1 - T6

Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{CES}	collector emitter voltage		$T_{VJ} = 150^\circ\text{C}$		600	V
V_{GES}	max. DC gate voltage	continuous			± 20	V
V_{GEM}	max. transient collector gate voltage	transient			± 30	V
I_{C25}	collector current		$T_C = 25^\circ\text{C}$		29	A
I_{C80}			$T_C = 80^\circ\text{C}$		20	A
P_{tot}	total power dissipation		$T_C = 25^\circ\text{C}$		100	W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 20 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.1 2.4	2.7	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.5 \text{ A}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	4.5	5.5	V
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		1.1	mA
I_{GES}	gate emitter leakage current	$V_{GE} = \pm 20 \text{ V}$			150	nA
C_{ies}	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$			900	pF
$Q_{G(on)}$	total gate charge	$V_{CE} = 300 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 20 \text{ A}$			76	nC
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 25^\circ\text{C}$ $V_{CE} = 300 \text{ V}; I_C = 20 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 47 \Omega$			35	ns
t_r	current rise time				45	ns
$t_{d(off)}$	turn-off delay time				155	ns
t_f	current fall time				75	ns
E_{on}	turn-on energy per pulse				0.39	mJ
E_{off}	turn-off energy per pulse				0.4	mJ
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 125^\circ\text{C}$ $V_{CE} = 300 \text{ V}; I_C = 20 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 47 \Omega$			35	ns
t_r	current rise time				45	ns
$t_{d(off)}$	turn-off delay time				165	ns
t_f	current fall time				150	ns
E_{on}	turn-on energy per pulse				0.6	mJ
E_{off}	turn-off energy per pulse				0.54	mJ
RBSOA	reverse bias safe operating area	$V_{GE} = \pm 15 \text{ V}; R_G = 47 \Omega; I_C = 40 \text{ A}$	$T_{VJ} = 125^\circ\text{C}$	$V_{CEK} \leq V_{CES} \cdot L_S \cdot d_I/dt$		V
I_{sc} (SCSOA)	short circuit safe operating area	$V_{CE} = 360 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 47 \Omega; t_p = 10 \mu\text{s}$	$T_{VJ} = 125^\circ\text{C}$	90		A
R_{thJC}	thermal resistance junction to case	(per IGBT)			1.3	K/W
R_{thCH}	thermal resistance case to heatsink				0.45	K/W

Output Inverter D1 - D6

Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{RRM}	max. repetitive reverse voltage		$T_{VJ} = 150^\circ\text{C}$		600	V
I_{F25}	forward current		$T_C = 25^\circ\text{C}$		37	A
I_{F80}			$T_C = 80^\circ\text{C}$		24	A
V_F	forward voltage	$I_F = 20 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.95 1.65	2.2	V
Q_{rr}	reverse recovery charge	$T_{VJ} = 125^\circ\text{C}$ $V_R = 300 \text{ V}$ $di_F/dt = -370 \text{ A}/\mu\text{s}$ $I_F = 20 \text{ A}; V_{GE} = 0 \text{ V}$			0.58	μC
I_{RM}	max. reverse recovery current				10.7	A
t_{rr}	reverse recovery time				110	ns
E_{rec}	reverse recovery energy				60	μJ
R_{thJC}	thermal resistance junction to case	(per diode)			1.6	K/W
R_{thCH}	thermal resistance case to heatsink				0.55	K/W

 $T_C = 25^\circ\text{C}$ unless otherwise stated

IXYS reserves the right to change limits, test conditions and dimensions.

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Input Rectifier Bridge D8 - D11**Ratings**

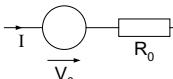
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{RRM}	max. repetitive reverse voltage		T _{VJ} = 25°C		1600	V
I_{FAV}	average forward current	sine 180°	T _C = 80°C		39	A
I_{DAVM}	max. average DC output current	rect.; d = 1/2	T _C = 80°C		42	A
I_{FSM}	max. forward surge current	t = 10 ms; sine 50 Hz	T _{VJ} = 25°C T _{VJ} = 125°C		550 tbd	A A
I²t	I ² t value for fusing	t = 10 ms; sine 50 Hz	T _{VJ} = 25°C T _{VJ} = 125°C		1270 tbd	A ² s A ² s
P_{tot}	total power dissipation		T _C = 25°C		100	W
V_F	forward voltage	I _F = 30 A	T _{VJ} = 25°C T _{VJ} = 125°C	1.2 1.3	1.5	V V
I_R	reverse current	V _R = V _{RRM}	T _{VJ} = 25°C T _{VJ} = 125°C	0.03 0.3	0.03	mA mA
R_{thJC}	thermal resistance junction to case	(per diode)			1.2	K/W
R_{thCH}	thermal resistance case to heatsink	(per diode)			0.4	K/W

Temperature Sensor NTC**Ratings**

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
R₂₅	resistance		T _C = 25°C	4.75	5.0 3375	kΩ K
B_{25/50}						

Module**Ratings**

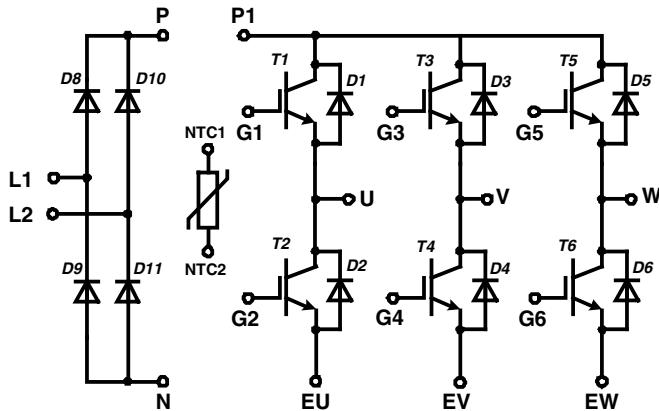
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
T_{VJ}	operating temperature		-40		125	°C
T_{VJM}	max. virtual junction temperature				150	°C
T_{stg}	storage temperature		-40		125	°C
V_{ISOL}	isolation voltage	I _{ISOL} ≤ 1 mA; 50/60 Hz			2500	V~
CTI	comparative tracking index			-		
F_c	mounting force		40		80	N
d_s	creep distance on surface		12.7			mm
d_A	strike distance through air		12			mm
Weight				35		g

Equivalent Circuits for Simulation**Ratings**

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V₀	rectifier diode	D8 - D11	T _{VJ} = 125°C	0.9 6		V mΩ
R₀						
V₀	IGBT	T1 - T6	T _{VJ} = 125°C	1.7 40		V mΩ
R₀						
V₀	free wheeling diode	D1 - D6	T _{VJ} = 125°C	1.25 12		V mΩ
R₀						

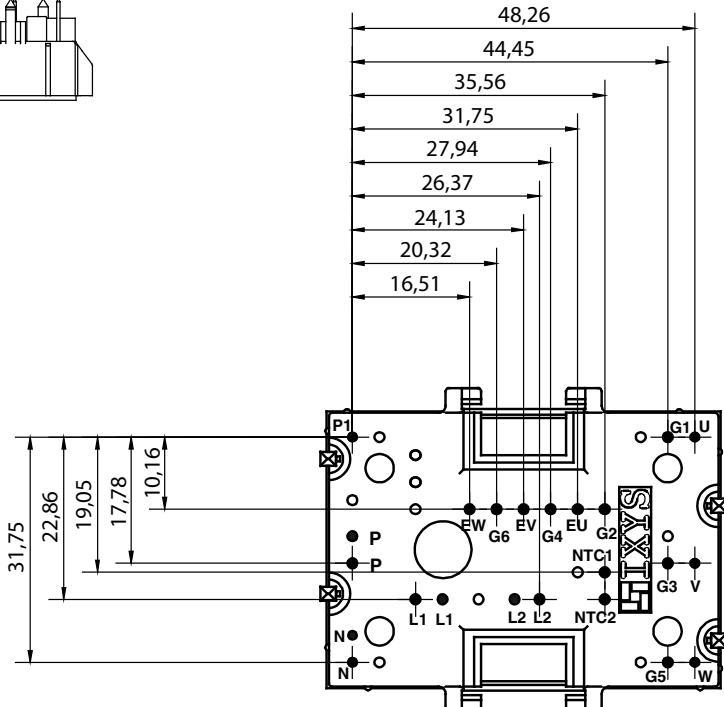
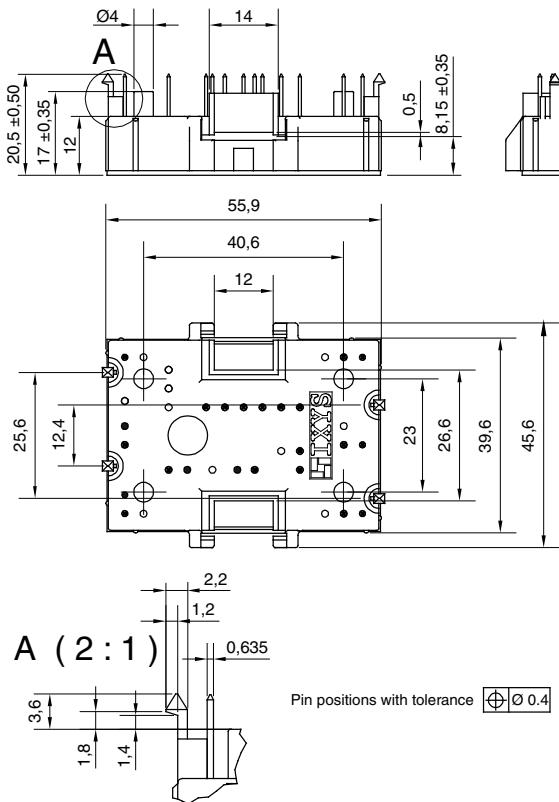
T_C = 25°C unless otherwise stated

Circuit Diagram

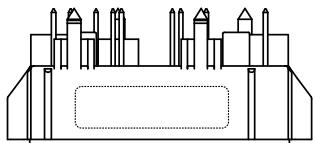


Outline Drawing

Dimensions in mm (1 mm = 0.0394")



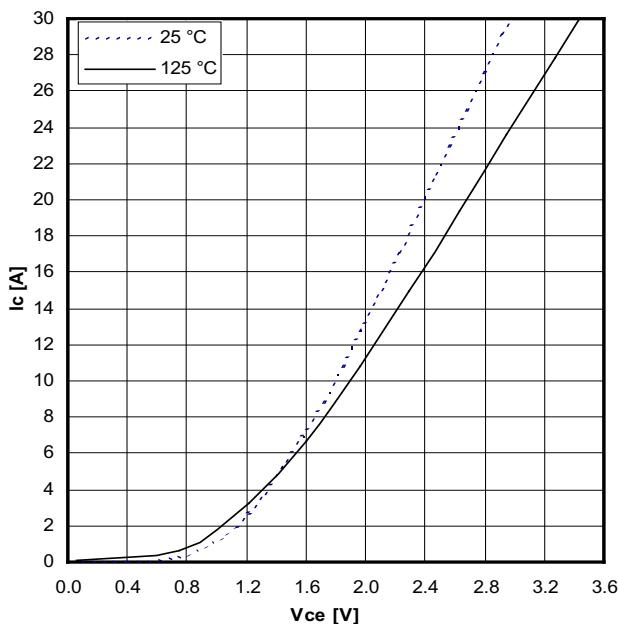
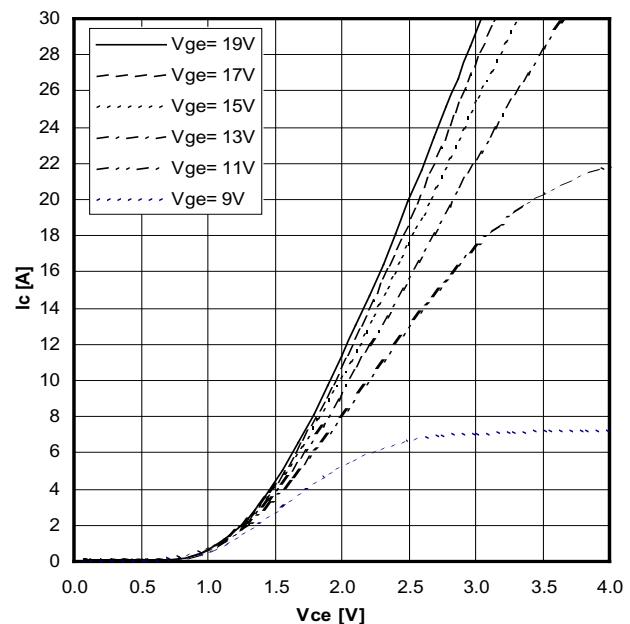
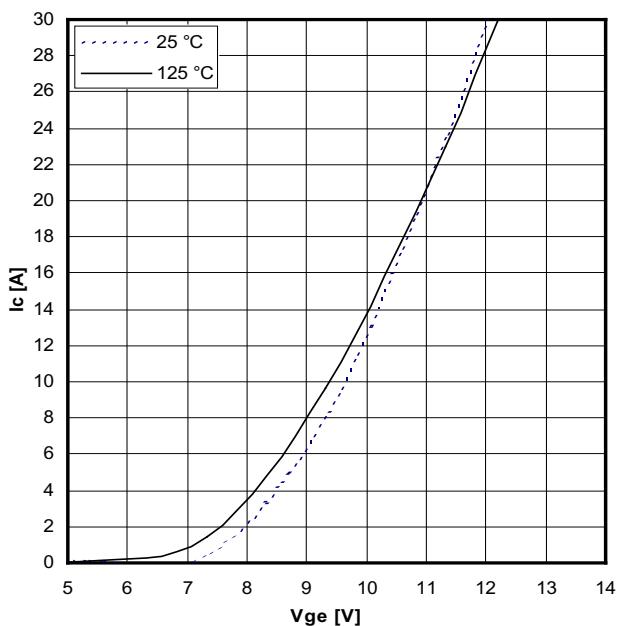
Product Marking



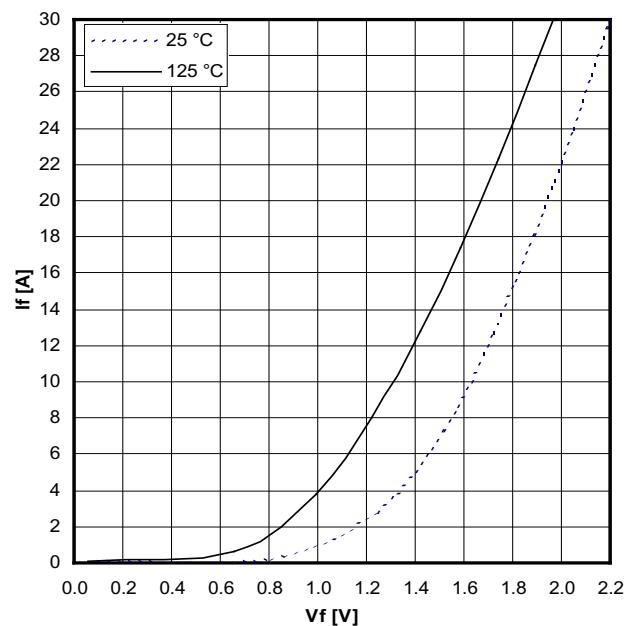
Part number

M = Module
 I = IGBT
 A = IGBT (NPT)
 A = Gen 1 / std
 20 = Current Rating [A]
 WD = 6-Pack + 1~ Rectifier Bridge
 600 = Reverse Voltage [V]
 T = NTC
 MH = MiniPack2

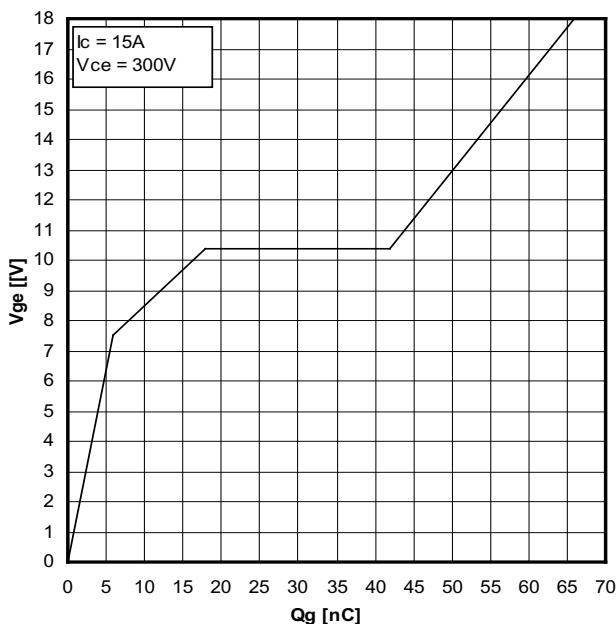
Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MIAA 20 WD 600 TMH	MIAA20WD600TMH	Box	20	504975

Typical output characteristics, $V_{GE} = 15$ VTypical output characteristics (125°C)

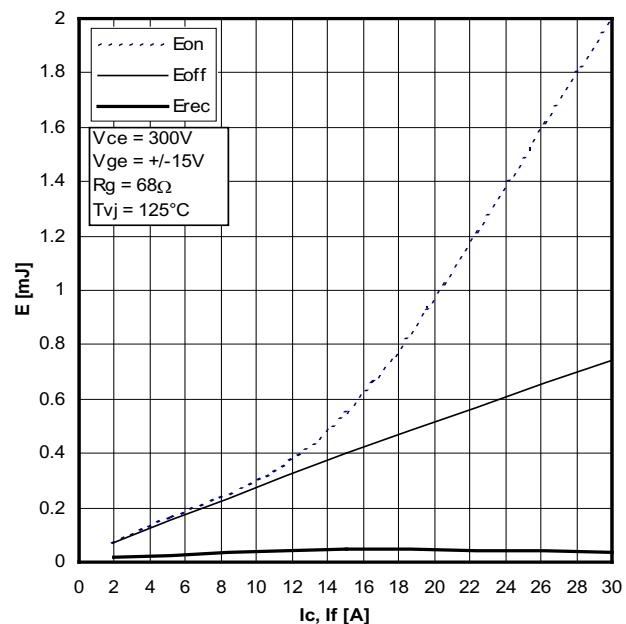
Typical transfer characteristics



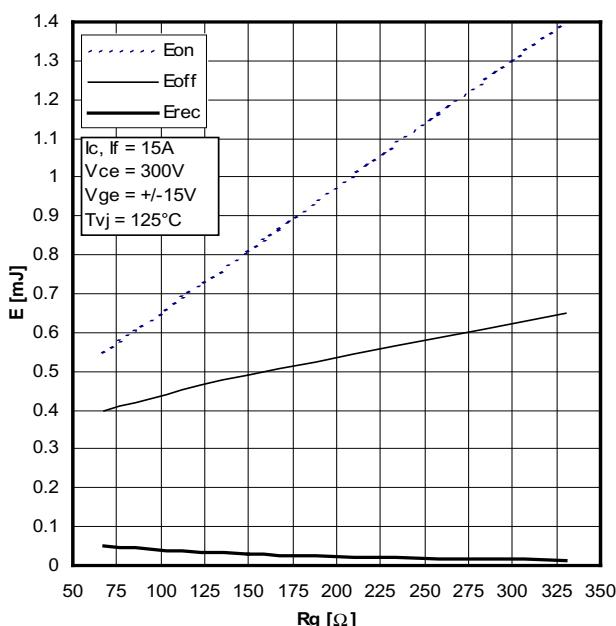
Typical forward characteristics of freewheeling diode



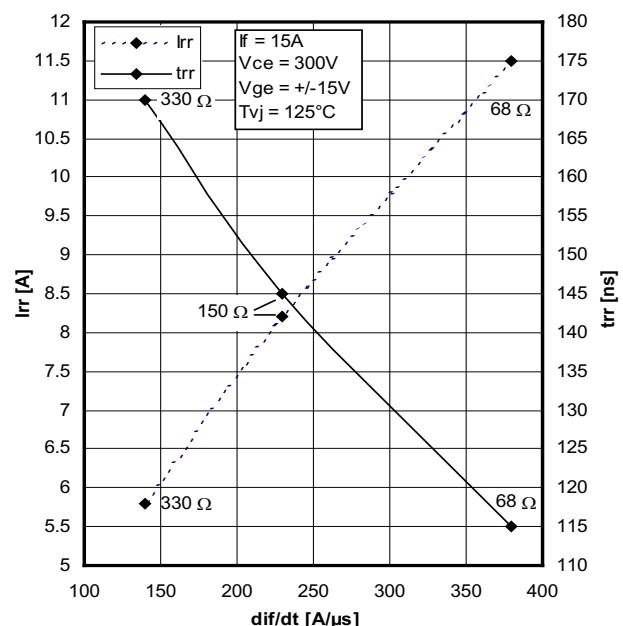
Typical turn on gate charge



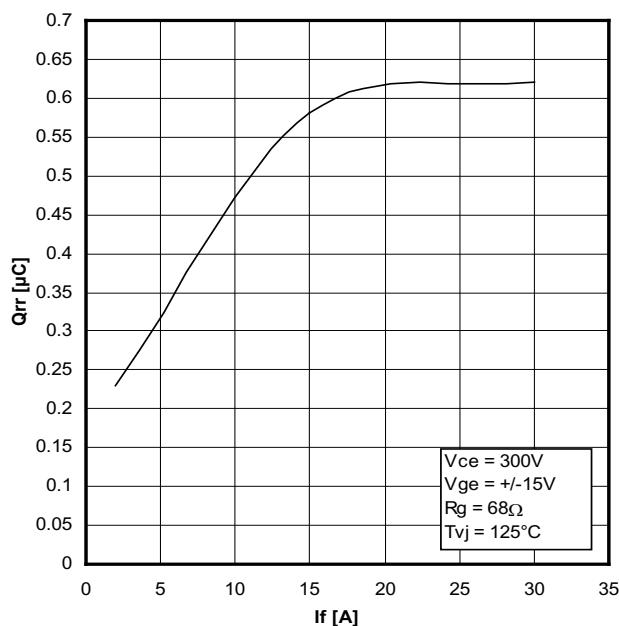
Typical switching energy versus collector current



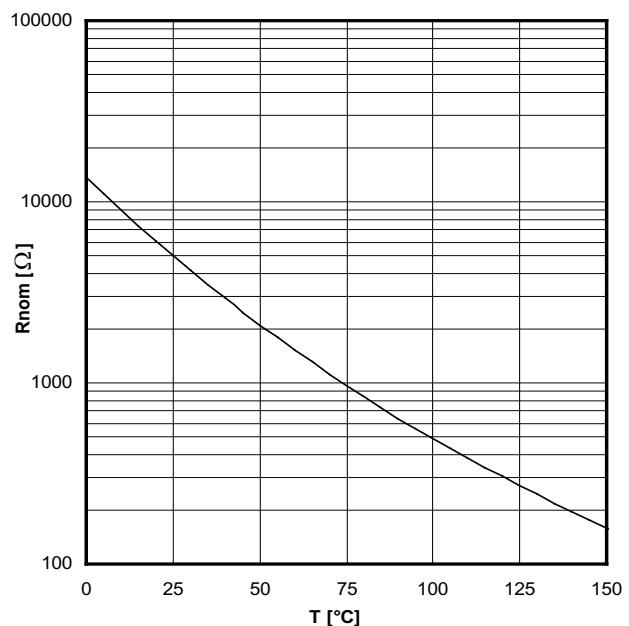
Typical switching energy versus gate resistance



Typical turn-off characteristics of free wheeling diode



Typical turn-off characteristics of free wheeling diode



Typical thermistor resistance versus temperature